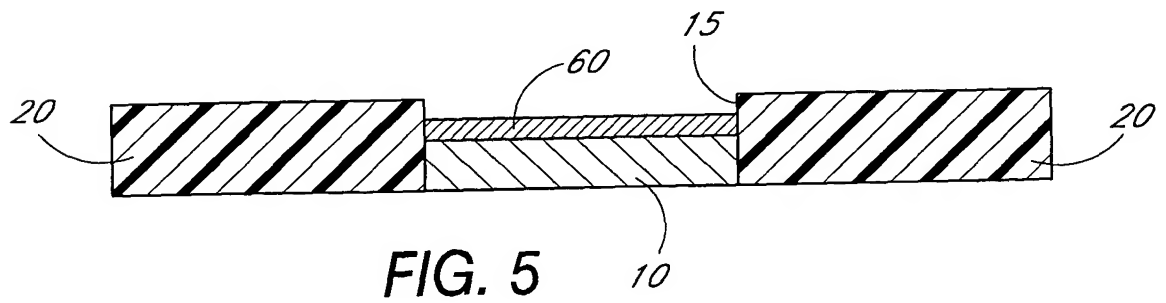
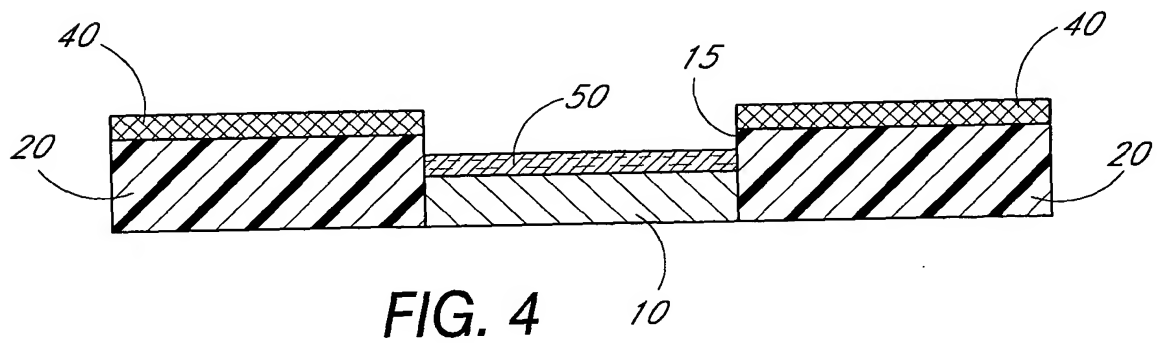
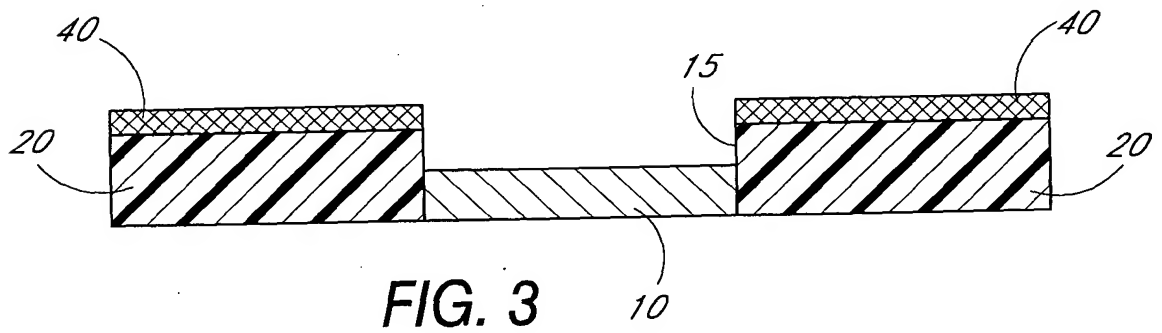
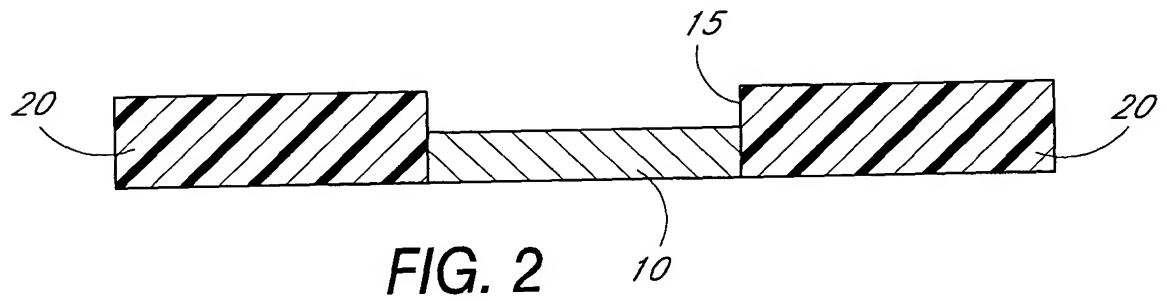
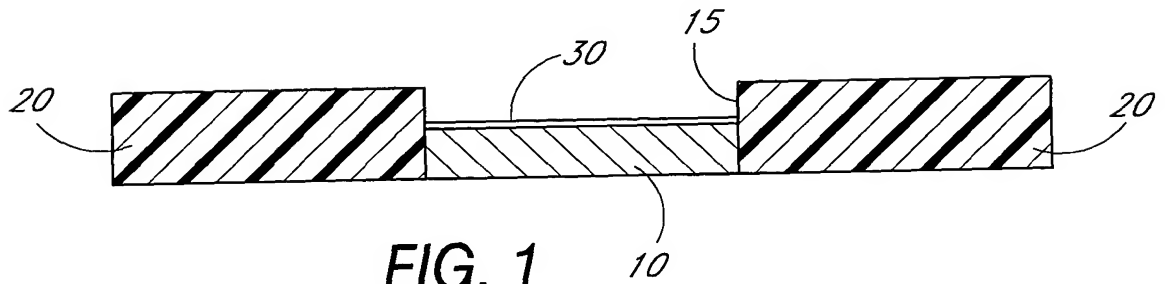


METHOD FOR ELECTROLESS PLATING A CONTACT PAD

Tongbi Jiang et al.

Appl. No.: Unknown

Atty Docket: MICRON.084C1C1



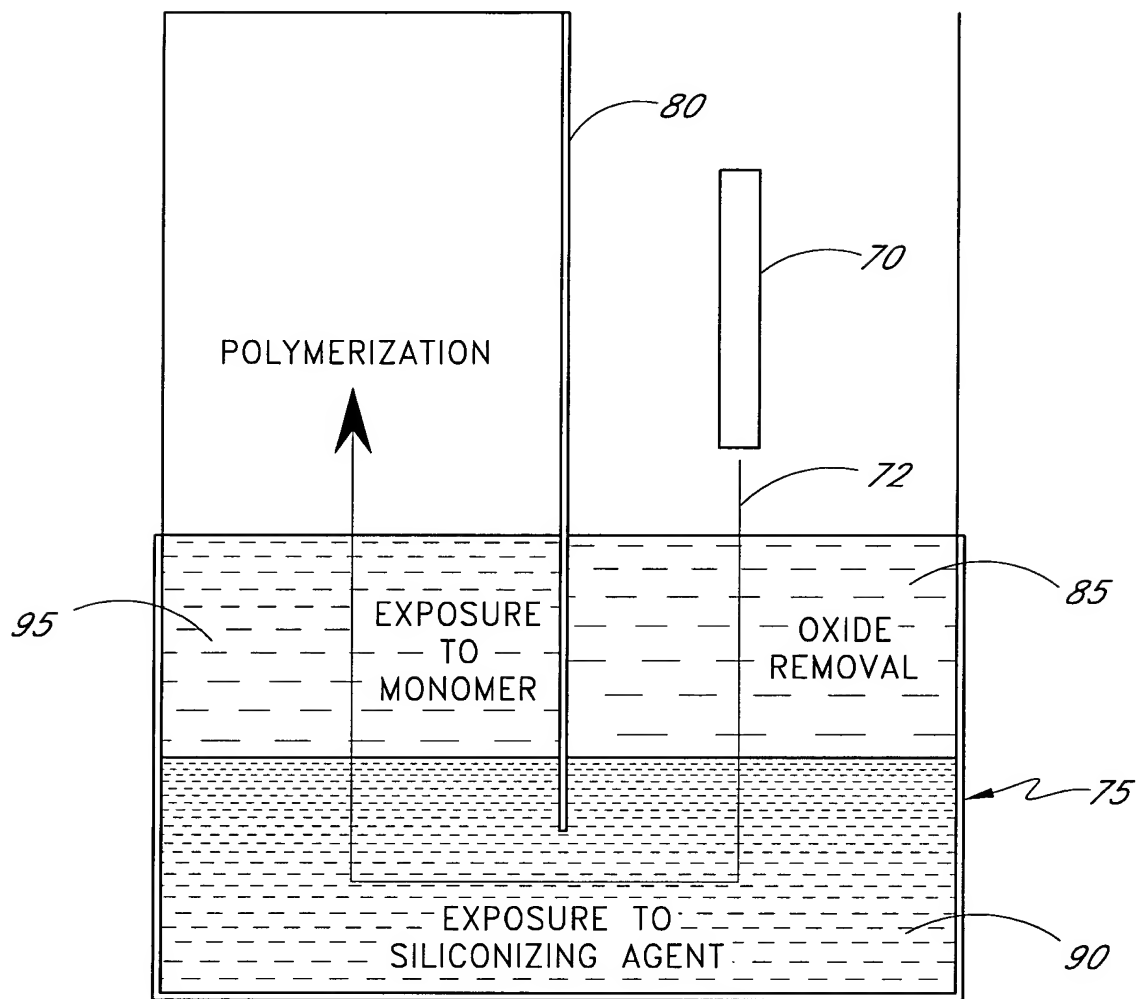


FIG. 6